Improved hazardous metal testing efficiency in microscopic areas with high sensitivity and high speed measurements

The EA6000VX enables control of hazardous substances over entire surfaces and measurement of microscopic points at a specified area. These tasks cannot be done by conventional instruments.

High sensitivity XRF Analyzer **EA6000X**

with hazardous element high speed mapping and measuring function



World class speed

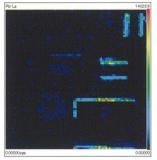
High speed mapping measurements

Rapidly obtains two dimensional element mapping images with its high-speed stage and greatly improved sensitivity of microscopic areas. Reinforces mapping of Pb on circuit boards and is equipped with a special Pb mapping filter. Eutectic solder can be detected after several minutes of mapping.

High resolution image



Two minute mapping image of Pb



Continuous multi-point measurements

Up to 500 points can be set and continuously measured as with an auto-sampler. Measuring large samples exhibits tremendous throughput.



Multi-point continuous measurements

Labar savings by setting up to 500 points for auto continuous measuring

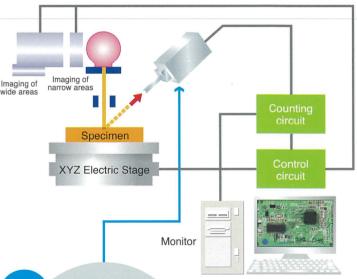


measurements

Microscopic area coating thickness measurements

The EA6000VX is capable of coating thickness measurements typical of the SFT series including coating thickness measurement of ultra-thin Au films. Analysis of hazardous substances such as Pb in plating can be measured simultaneously with coating thickness measurements.

Instrument Configuration

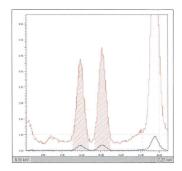




High Sensitivity

Equipped with a detector that does not need liquid nitrogen. A general-purpose bench top with a Vortex, the world's best high count rate detector.

Great strides in high sensitivity realized by "optimized complete X-ray optic system", high count rate detector, and large areas. Remarkablely improved sensitivity of 1mm beam, realizing 10 times the sensitivity of conventional instruments

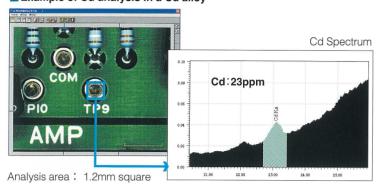


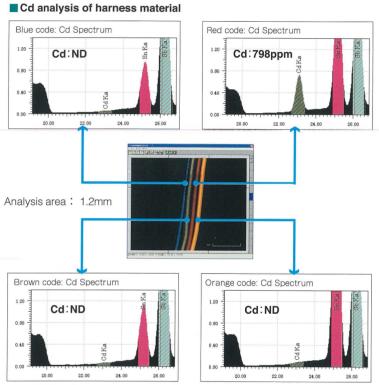
Blue line: conventional 1mm beam. Red line: EA6000VX 1.2mm square beam. Sample: Pb and Hg (100ppm) in polyethelene.

Example of RoHS analysis

In a sample that combines multiple substances, measuring can be done by using a micro X-ray beam aimed at a specific spot.

■ Example of Cd analysis in a Cu alloy





High speed measurement of trace metals in micro-areas

Rapid measurement of trace metals and thin films in microscopic areas.

	Cd, Pb, Cr in brass	Pb in Sn	Cd, Pb, Hg, Br, Cr, in plastic
□3mm	80sec	40sec	70sec
□1.2mm	150sec	40sec	80sec

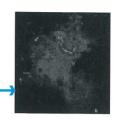
The detection lower limit of Cd is 30ppm and the other elements is 200ppm

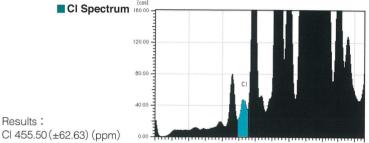
Measure CI concentration in PCB Assemblies

To meet halogen-free needs, high sensitivity in microscopic areas is realized in measuring CI and Br. Since the irradiation method is top-down, pinpoint measurement positioning is possible even on boards that have uneven surfaces.



Analysis area: Square 3mm Measuring time: 300 seconds





■ Specification

Results:

Specification			
Elements	Atomic nos. 12 (Mg) to 92 (U)		
	*Atomic nos. when using helium purge 11 (Na) to 92 (U)		
Sample state	Solid / Powder / Liquid		
X-ray source	Air-cooled X-ray tube (W target)		
	Voltage: 15kV, 30kV, 40kV, 50kV		
	Current: 20 to 1000uA		
X-ray direction	Top-down Irradiation		
Detection	Vortex Si semiconductor detector (No liquid nitrogen required		
Analysis area (beam size)	Square 0.2mm, 0.5mm, 1.2mm, 3mm Electric switching		
Sample Observation	High resolution CCD camera, 2 system		
Chamber	580 (W) x 450 (D) X 150 (H) mm,		
CHAITIBOI	Both point analysis and mapping for		
	entire 250 (X) X 200 (Y) mm		
Filter	6 mode electric switching		
Controller	Desktop PC and 19" LCD monitor		
Options	Helium purge, Joustick controller, Signal tower, Dual monitor Standard Samples for Hazardous Substances Printer, Precision control software.		
Mapping functions	Align with sample image, Area integrated spectral display, Quantitative integrated function		
Qualitative functions	Spectrum measurement, Auto-ID, Comparison display		
Quantitative functions	Bulk CAL, Bulk FP, Film CAL, Film FP		
Data Process	Microsoft® Excel, Microsoft® Word		
Safety functions	Door interlock, Crash protection, Instrument seld-diagnosis		
Power requirements (Electric box included AC100V to 240V ±10%, 750VA max.			

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